YAORP (Yet Another Open Reflow Plate)

Status: Prototype

Issued 2025-02-19

Rev 1.1

PROJECT ARCHITECTURE

Power – 240AC to 5VDC

File: sch_power_ACto5VDC.kicad_sch

Power – 3v3DC

File: sch_power_3v3DC.kicad_sch

IO – Thermocouple

File: sch_io_thermocouple.kicad_sch

IO – Cooling Fan

File: sch_io_fan.kicad_sch

PCB – Mounts

File: sch_pcb_mounts.kicad_sch

MCU – ESP32 S3 Wroom 1

File: sch_mcu_esp32s3wroom1.kicad_sch

IO – PTC Plate

File: sch_io_ptc.kicad_sch

IO – Misc

File: sch_io_misc.kicad_sch

PROJECT DESCRIPTION

A design for a solder reflow plate for SMD rework using commonly available aluminium mains powered 400W PTC (positive temperature coefficient) heating plate from AliExpress.

Temperature is determined using a K type thermocouple and MAX31855. The PTC is driven by an SSR (solid state relay) using PWM and controlled by a PID. An ESP32 S3 Wroom 1 module forms the heart of the design and firmware is written in C++ for Arduino IDE.

PROJECT NOTES

1. This is board 1 of a 2 board design. Board 2 is a heat deflector/cooler to insulate PTC heating plate from mounting box etc.

2. Firmware is developed using Arduino IDE and has been tested using protype components and is a MVP. Firmware tested using MAX6675 thermocouple controller so will need to be updated to reflect the final design.

DESIGN NOTES KEY

DESIGN NOTE:
Example text for informational design notes.

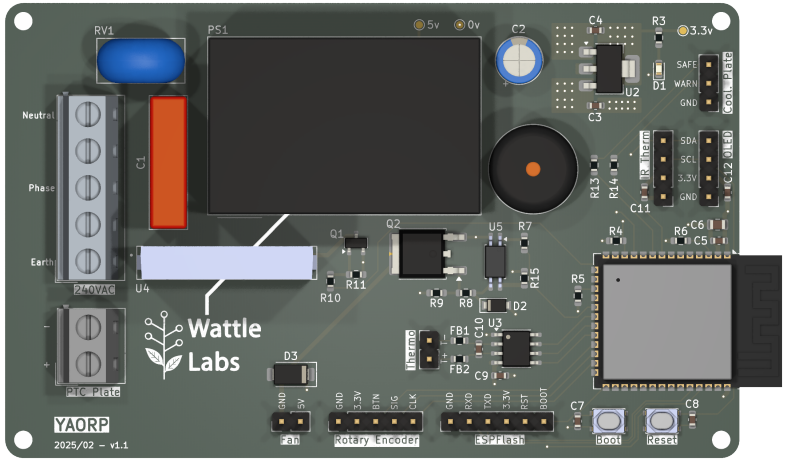
DESIGN NOTE:
Example text for cautionary design notes.

DESIGN NOTE:
Example text for critical design notes.

LAYOUT NOTE:
Example text for critical layout guidelines.

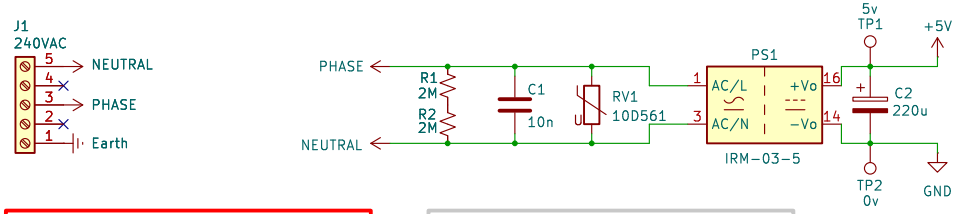
DRAFT – Very early stage of schematic, ignore details.
PRELIM – Close to final schematic.
PROTOTYPE – Untested in its built form.
TESTED – A board with this schematic has been built and tested.

TOP VIEW



Title: YAORP (Yet Another Open Reflow Plate)			Wattle Labs
Sheet: / File: Board1.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 1/10	KiCad E.D.A. 8.0.8

[2] Mains to 5v DC Power Supply



DESIGN NOTE:

Skipped pins 2&4 on J1 is intended to provide additional trace clearance VS finding a larger part (copper has been removed from PCB holes).

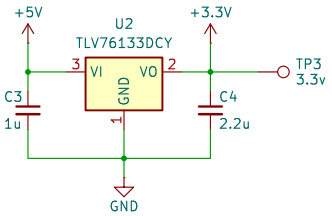
DESIGN NOTE:

Mains side 2A fuse is intended to be offboard (being built into IEC power receptable).

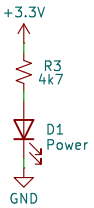
Title: Mains to 5v DC Power Supply			Wattle Labs
Sheet: /Power - 240AC to 5VDC/ File: sch_power_ACto5VDC.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 2/10	KiCad E.D.A. 8.0.8

[3] 3.3v DC Power Supply

LDO Linear Regulator



Power LED



DESIGN NOTE:

V_{IN}: 2.5V–16V (20V abs max)

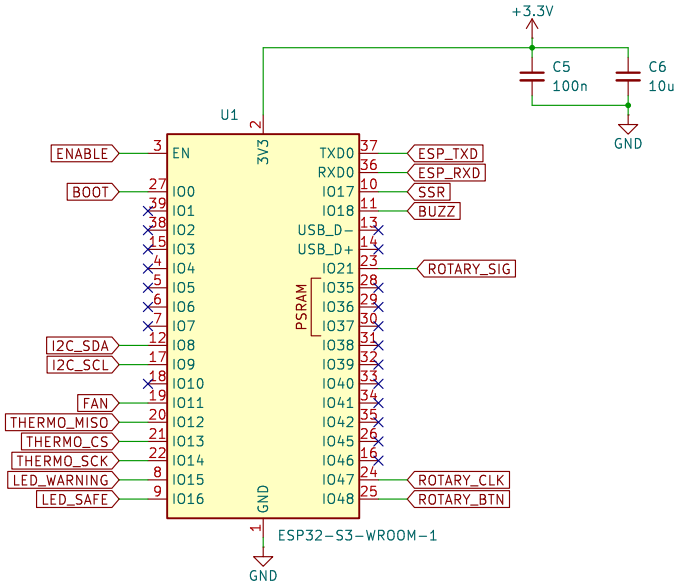
V_{OUT}: fixed 3.3V, max 1A

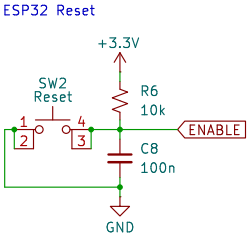
$V_{DROPOUT}$: 0.6 @ 800mA

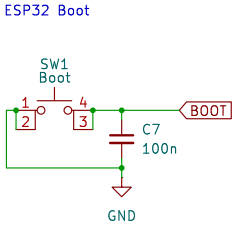
I_Q: 60uA (~1.5uA in shutdown)

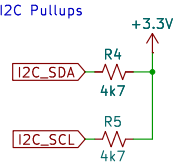
Title: 3.3v DC Power Supply			Wattle Labs
Sheet: /Power – 3v3DC/ File: sch_power_3v3DC.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 3/10	KiCad E.D.A. 8.0.8

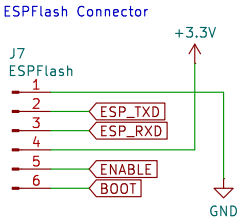
[4] ESP32-S3-WROOM-1 Module









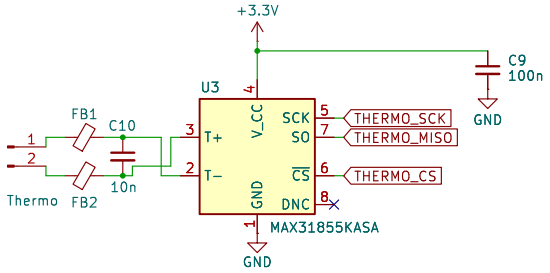


DESIGN NOTE:

This could be removed in favour of a USB connectorhowever cost uplift and slightly more complex to route. The firmware is unlikely to be updated often AND could be done OTA.

Title: ESP32-S3-WROOM-1 Module			Wattle Labs
Sheet: /MCU - ESP32 S3 Wroom 1/ File: sch_mcu_esp32s3wroom1.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 4/10	KiCad E.D.A. 8.0.8

[5] Type K Thermocouple (MAX31855) Driver

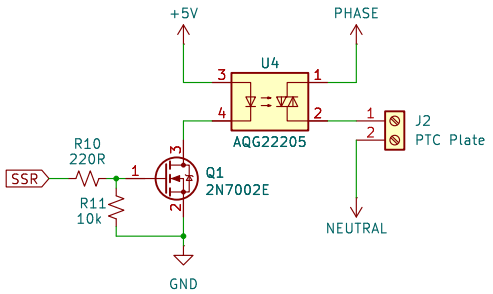


DESIGN NOTE:

1. Capacitors are those recommended in MAX31855 datasheet.
2. Firmware PoC tested with MAX6675 but MAX31855 is newer part (NOT pin compatible)
3. Ferrites added in v1.1 to deal with potential EMI issues (MAX31855 is sensitive).

Title: Type K Thermocouple (MAX31855) Driver			Wattle Labs
Sheet: /IO – Thermocouple/ File: sch_io_thermocouple.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 5/10	KiCad E.D.A. 8.0.8

[6] Solid State Relay to drive PTC Plate

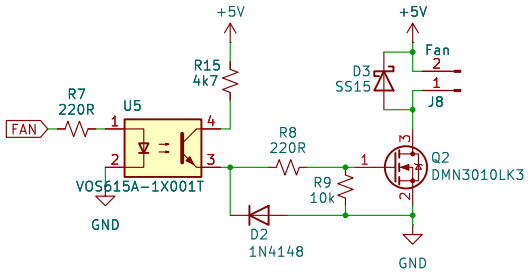


DESIGN NOTE:

SSR is a 5V drive thus MOSFET required to enhance ESP32 GPIO.

Title: Solid State Relay to drive PTC Plate			Wattle Labs
Sheet: /IO – PTC Plate/ File: sch_io_ptc.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 6/10	KiCad E.D.A. 8.0.8

[7] Cooling Fan Driver



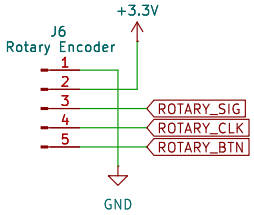
DESIGN NOTE:

Optocoupler used to buffer 3.3v to 5v drive for MOSFET

Title: Cooling Fan Driver			Wattle Labs
Sheet: /IO – Cooling Fan/ File: sch_io_fan.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 7/10	KiCad E.D.A. 8.0.8

[8] Misc I/O

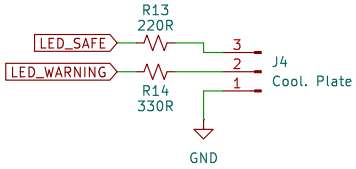
Rotary Encoder Connector



DESIGN NOTE:

Encoder module includes pullups

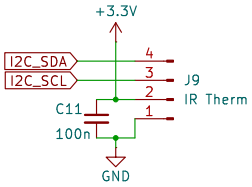
Cooling Plate LED Connector



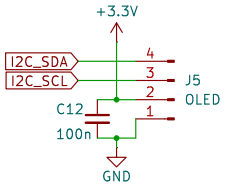
DESIGN NOTE:

LEDs live on a seperate schematic/PCB (board 2)

Cooling Plate IR Thermometer Connector



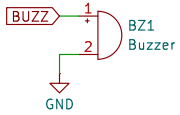
OLED Connector



DESIGN NOTE:

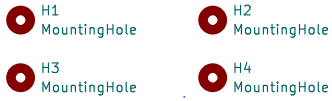
SSD1306 128X64 pixel 1.5" OLED

Buzzer



Title: Misc I/O			Wattle Labs
Sheet: /IO – Misc/ File: sch_io_misc.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 8/10	KiCad E.D.A. 8.0.8

[9] Mounting Holes



Title: Mounting Holes			Wattle Labs
Sheet: /PCB – Mounts/ File: sch_pcb_mounts.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 9/10	KiCad E.D.A. 8.0.8

[11] Revision History

19-Feb-2025 - Rev 1.1
Status: Prototype

* Removed LED for SSR indicator from board2 (and board1 pin header). It was found that this LED reduced the SSR outout and became impossible to get PTC plate to 200degC. Plan to implement a "power meter" bar graph in the OLED to show SSR drive.

* Added InfraRed temperature sensor (MLX90614ESF) to board2 (and board1 pin header). This will read temperature from beneath the hot plate (and is somewhat of an experiement therefore the thermocouple driver remains on board).

* Added ferrite beads to thermocouple inputs to reduce potential for EMI to upset temperature readings.

xx-xxx-20xx
Status: ???

xx-xxx-20xx
Status: ???

Title: Revision History			Wattle Labs
Sheet: /Revision History/ File: project history.kicad_sch			
Rev: 1.1	Date: 2025-02-19	Id: 11/10	KiCad E.D.A. 8.0.8